



**SCHOTTKY DIODE MODULE TYPE 300A**

**Features**

- High Surge Capability
- Type 200V  $V_{RRM}$
- Isolation Type Package
- Electrically Isolation Base Plate

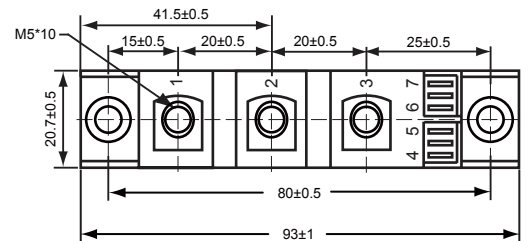
**Maximum Ratings**

Junction Operating Temperature :  $-55^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$   
 Storage Temperature :  $-55^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$



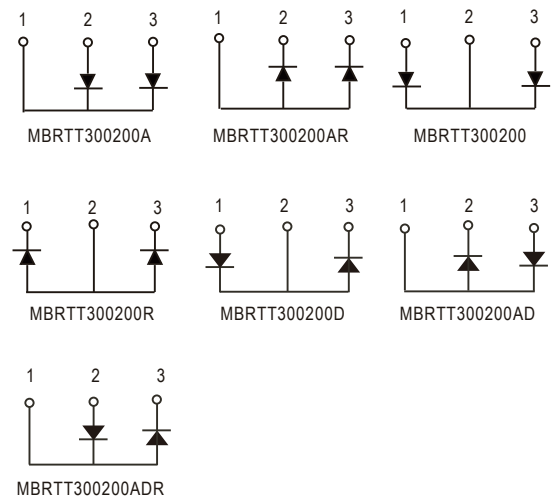
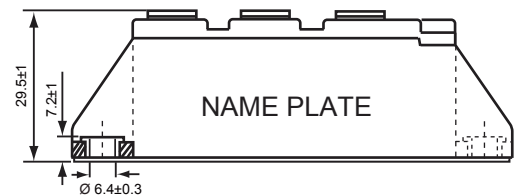
Dimensions in mm (1mm = 0.0394")

Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
MBRTT300200(A)(D)(R)	200V	140V	200V



**Electrical Characteristics @ 25°C Unless Otherwise Specified**

Average Forward Current (Per pkg) (Per diode)	$I_{F(AV)}$	300A 150A	$T_c = 125^{\circ}\text{C}$
Peak Forward Surge Current (Per diode)	$I_{FSM}$	2000A	8.3ms, half sine
Maximum Instantaneous Forward Voltage* (Per diode)	$V_F$	0.86V 0.96V	$I_{FM} = 150\text{A}; T_J = 125^{\circ}\text{C}$ $I_{FM} = 150\text{A}; T_J = 25^{\circ}\text{C}$
Maximum Instantaneous Reverse Current At Rated DC Blockig Voltage* (Per diode)	$I_R$	3mA 8mA 15mA	$T_J = 25^{\circ}\text{C}$ $T_J = 125^{\circ}\text{C}$ $T_J = 150^{\circ}\text{C}$
Isolation Voltage	$V_{iso}$	2500V	A.C. 1 minute
Maximum Thermal Resistance Junction To Case (Per diode)	$R_{\theta jc}$	0.40°C/W	
Mounting Torque		4 ± 0.5Nm 3 ± 0.5Nm	to heatsink to terminals



\*Pulse Test: Pulse Width 300µsec, Duty Cycle < 2%



Figure.1 - Typical Forward Characteristics

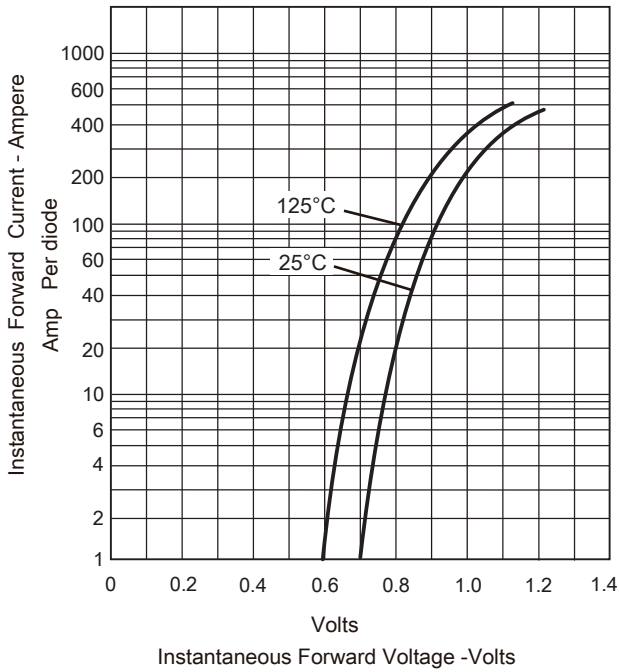


Figure.2 - Forward Derating Curve

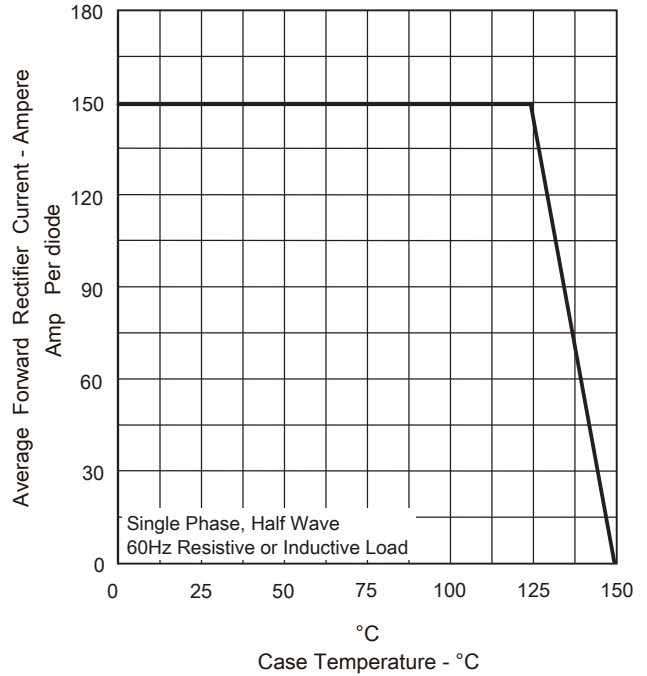


Figure.3 - Peak Forward Surge Current

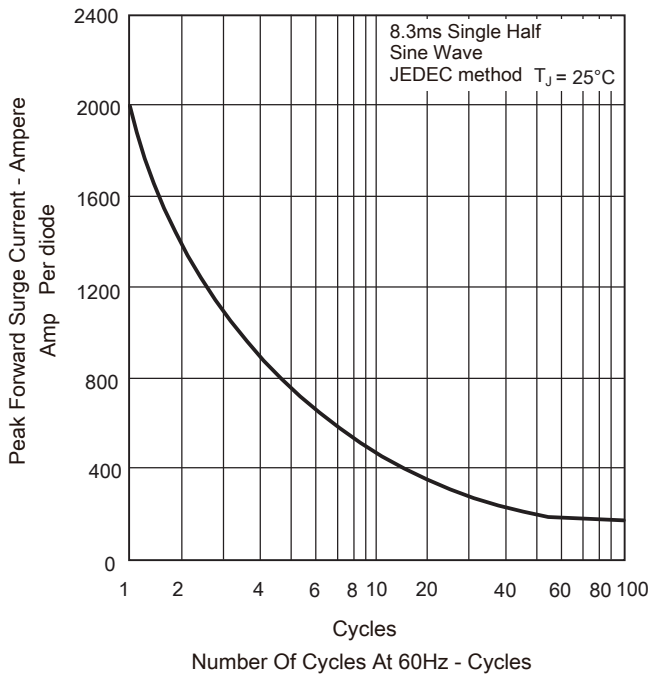
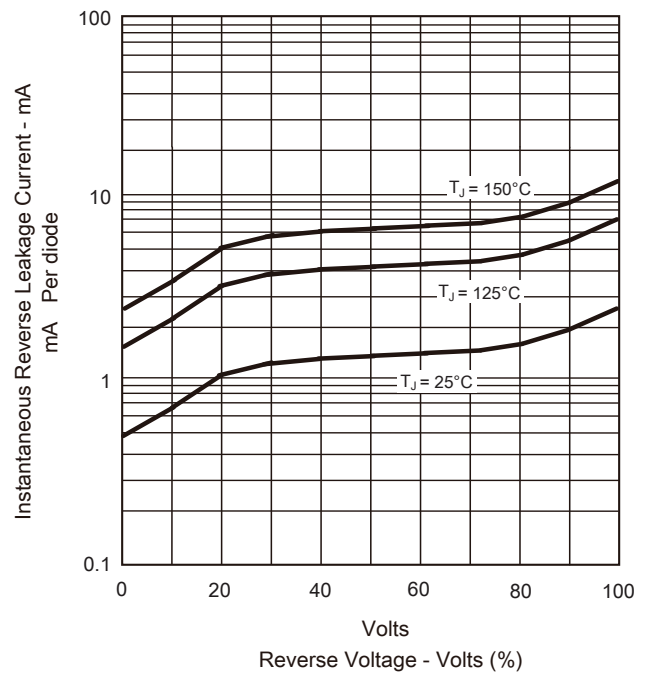


Figure.4 - Typical Reverse Characteristics





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